

## **LISTING OF CLAIMS**

This listing of claims will replace all prior versions, and listings, of claims in the application:

Claims 1-18 (Canceled)

19. (Currently Amended) A method for manufacturing storage devices for plate-shaped data carriers, each of said storage devices having a first and a second cover pivotally connected, a fixing means for fixing the data carrier within the storage device, said storage device being injection molded from plastic, and a protective means, the method comprising the steps of:

placing a first protective means in a mold and subsequently forming at least a portion of a first storage device against or around the first protective means in the mold through injection molding, such that the first protective means cannot be removed from the relevant part without damage, said first protective means having product information specific to a first data carrier to be stored in said first storage device; ~~and~~

placing a second protective means in the mold and subsequently forming at least a portion of a second storage device against or around said second protective means by injection molding, said second protective means having product information specific to a second data carrier to be stored in said second storage device, wherein said product information of said first protective means is different from said product information of said second protective means; and

controlling the placing of the first and second protective means with a computer,  
wherein said product information for each individual data carrier can be adjusted.

20. (Previously Presented) A method according to claim 19, wherein both the first and second storage devices are injection molded in one piece.

21. (Previously Presented) A method according to claim 19, wherein said first and second protective means comprise a printing provided in the mold prior to forming said storage devices, said printing of said first protective means being different from said printing of said second protective means and whereupon plastic in the mold is provided against the printing or a carrier carrying the printing, such that the printing will form an integral part of the storage device or a part thereof to be formed in the mold.

22. (Previously Presented) A method according to claim 21, wherein the printing is introduced into the mold on a carrier.

23. (Previously Presented) A method according to claim 22, wherein the carrier is turned towards the adjacent wall of the mold and the plastic is provided against the opposite side.

24. (Previously Presented) A method according to claim 22, wherein the carrier is slightly stretched before or during placement in the mold, such that it is pulled taut.

25. (Previously Presented) A method according to claim 22, wherein such a carrier is applied that under the influence of at least the temperature of the plastic provided there against, it burns or sublimes, while the printing is incorporated on or into the plastic.

26. (Previously Presented) A method according to claim 22, wherein the carrier fuses with the plastic.

27. (Previously Presented) A method according to claim 22, wherein the carrier with printing is supplied as a strip, in particular from a roll, and is cut directly before or during placement.

28. (Previously Presented) A method according to claim 21, wherein the printing is designed as transfer ink.

29. (Withdrawn) A method according to claim 21, wherein the printing (35, 123) is provided in the mold (101) through impressing or printing on a wall part of the mold (101) or a carrier provided thereon.

30. (Withdrawn) A method according to claim 21, wherein a holographic printing (35, 123) is provided.

31. (Withdrawn) A method according to claim 21, wherein a bar-code (36) or the like is provided.

32. (Previously Presented) A method according to claim 21, wherein a carrier is provided in the mold having a printing on two sides, the plastic being provided against the carrier and undetachably connected thereto.

33. (Original) A method according to claim 32, wherein the carrier is at least partially transparent.

34. (Withdrawn) A method according to claim 19, wherein the protective means (35, 123, 38, 38a, 36, 37) comprise magnetic and/or electronic means which are positioned on a carrier in the mold (101), whereupon plastic is squirted around the magnetic and/or electronic means, such that the carrier is enclosed or incorporated therein or disappears therein, for instance through burning or sublimation.

Claims 35-41 (Canceled)